26 STM32F40xxx/41xxx devices bootloader

26.1 Bootloader V3.x

26.1.1 Bootloader configuration

The STM32F40xxx/41xxx bootloader is activated by applying Pattern 1 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 53. STM32F40xxx/41xxx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
Common to all bootloaders	RCC	HSI enabled	The system clock frequency is 24 MHz using the PLL. The HSI clock source is used at startup (interface detection phase) and when USARTx interfaces are selected (once CAN or DFU bootloader is selected, the clock source is derived from the external crystal).
		HSE enabled	The system clock frequency is 60 MHz. The HSE clock source is used only when the CAN or the DFU (USB FS Device) interfaces are selected. The external clock must provide a frequency multiple of 1 MHz and ranging from 4 MHz to 26 MHz.
		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock generates system reset.
	RAM	-	8 Kbyte starting from address 0x20000000 are used by the bootloader firmware.
	System memory	-	29 Kbyte starting from address 0x1FFF 0000 contain the bootloader firmware.
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to [1.62 V, 2.1 V]. In this range internal Flash write operations are allowed only in byte format (Half-Word, Word and Double-Word operations are not allowed). The voltage range can be configured in run time using bootloader commands.

Table 53. STM32F40xxx/41xxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART1 bootloader	USART1	Enabled	Once initialized, the USART1 configuration is: 8 bits, even parity and 1 Stop bit.
	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART3 bootloader (on PB10/PB11)	USART3	Enabled	Once initialized, the USART3 configuration is: 8 bits, even parity and 1 Stop bit.
	USART3_RX pin	Input	PB11 pin: USART3 in reception mode
	USART3_TX pin	Output	PB10 pin: USART3 in transmission mode
USART3 bootloader (on PC10/PC11)	USART3	Enabled	Once initialized, the USART3 configuration is: 8 bits, even parity and 1 Stop bit.
	USART3_RX pin	Input	PC11 pin: USART3 in reception mode
	USART3_TX pin	Output	PC10 pin: USART3 in transmission mode
USARTx bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
CAN2 bootloader	CAN2	Enabled	Once initialized, the CAN2 configuration is: Baudrate 125 kbps, 11-bit identifier. **Note:** CAN1 is clocked during CAN2 bootloader execution because CAN1 manages the communication between CAN2 and SRAM.
	CAN2_RX pin	Input	PB5 pin: CAN2 in reception mode
	CAN2_TX pin	Output	PB13 pin: CAN2 in transmission mode
DFU bootloader	USB	Enabled	USB OTG FS configured in forced device mode
	USB_DM pin	Input/Output	PA11: USB DM line.
	USB_DP pin		PA12: USB DP line No external pull-up resistor is required
CAN2 and DFU bootloaders	TIM11	Enabled	This timer is used to determine the value of the HSE. Once the HSE frequency is determined, the system clock is configured to 60 MHz using PLL and HSE.

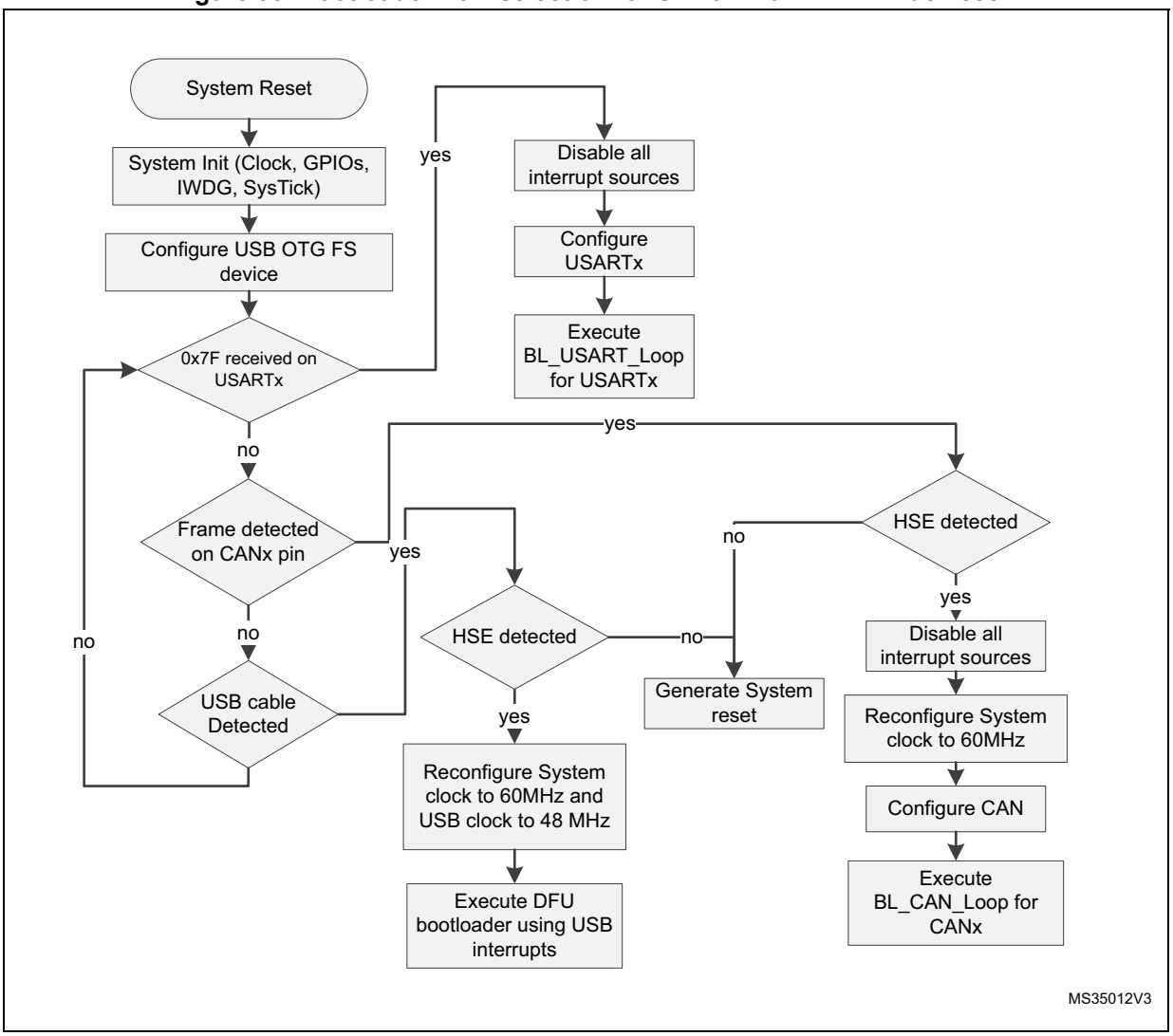
The system clock is derived from the embedded internal high-speed RC for USARTx bootloaders. This internal clock is also used for CAN and DFU (USB FS Device) but only for the selection phase. An external clock multiple of 1 MHz (between 4 and 26 MHz) is required for CAN and DFU bootloader execution after the selection phase.

Note: Due to HSI deviation and since HSI is used to detect HSE value, the user must use low frequency rather than high frequency HSE crystal values (low frequency values are better detected due to larger error margin). For example, it is better to use 8 MHz instead of 25 MHz.

26.1.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

Figure 30. Bootloader V3.x selection for STM32F40xxx/41xxx devices



26.1.3 Bootloader version

The following table lists the STM32F40xxx/41xxx devices V3.x bootloader versions:

Table 54. STM32F40xxx/41xxx bootloader V3.x versions

Bootloader version number	Description	Known limitations
V3.0	Initial bootloader version	– When a Read Memory command or Write Memory command is issued with an unsupported memory address and a correct address checksum (i.e. address 0x6000 0000), the command is aborted by the bootloader device, but the NACK (0x1F) is not sent to the host. As a result, the next 2 bytes (which are the number of bytes to be read/written and its checksum) are considered as a new command and its checksum(1). – Option bytes, OTP and Device Feature descriptors (in DFU interface) are set to “g” instead of “e” (not erasable memory areas). After executing Go command (jump to user code) the bootloader resets AHB1ENR value to 0x0000 0000 and thus CCM RAM, when present, is not active (must be re-enabled by user code at startup)
V3.1	Fix V3.0 limitations. DFU interface robustness enhancement.	– For the USART interface, two consecutive NACKs (instead of 1 NACK) are sent when a Read Memory or Write Memory command is sent and the RDP level is active. – For the CAN interface, the Write Unprotect command is not functional. Use Write Memory command and write directly to the option bytes in order to disable the write protection. After executing Go command (jump to user code) the bootloader resets AHB1ENR value to 0x0000 0000 and thus CCM RAM, when present, is not active (must be re-enabled by user code at startup)

1. If the “number of data - 1” (N-1) to be read/written is not equal to a valid command code (0x00, 0x01, 0x02, 0x11, 0x21, 0x31, 0x43, 0x44, 0x63, 0x73, 0x82 or 0x92), then the limitation is not perceived from the host since the command is NACKed anyway (as an unsupported new command).

26.2 Bootloader V9.x

26.2.1 Bootloader configuration

The STM32F40xxx/41xxx bootloader is activated by applying Pattern 1 (described in *Table 2: Bootloader activation patterns*). *Table 55* shows the hardware resources used by this bootloader.

Note: The bootloader version V9.x is embedded only in STM32F405xx/415xx devices in WLCSP90 package.

Table 55. STM32F40xxx/41xxx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
Common to all bootloaders	RCC	HSI enabled	The system clock frequency is 60 MHz using the PLL. The HSI clock source is used at startup (interface detection phase) and when USART or SPI or I2C interfaces are selected (once CAN or DFU bootloader is selected, the clock source is derived from the external crystal).
		HSE enabled	The system clock frequency is 60 MHz. The HSE clock source is used only when the CAN or the DFU (USB FS Device) interfaces are selected. The external clock must provide a frequency multiple of 1 MHz and ranging from 4 MHz to 26 MHz.
		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock generates system reset.
	RAM	-	12 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	29 Kbyte starting from address 0x1FFF0000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to [1.62 V, 2.1 V]. In this range internal Flash write operations are allowed only in byte format (Half-Word, Word and Double-Word operations are not allowed). The voltage range can be configured in run time using bootloader commands.

Table 55. STM32F40xxx/41xxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART1 bootloader	USART1	Enabled	Once initialized the USART1 configuration is: 8-bit, even parity and 1 Stop bit
	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART3 bootloader (on PB10/PB11)	USART3	Enabled	Once initialized the USART3 configuration is: 8-bit, even parity and 1 Stop bit
	USART3_RX pin	Input	PB11 pin: USART3 in reception mode
	USART3_TX pin	Output	PB10 pin: USART3 in transmission mode
USART3 bootloader (on PC10/PC11)	USART3	Enabled	Once initialized the USART3 configuration is: 8-bit, even parity and 1 Stop bit
	USART3_RX pin	Input	PC11 pin: USART3 in reception mode
	USART3_TX pin	Output	PC10 pin: USART3 in transmission mode
USARTx bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
CAN2 bootloader	CAN2	Enabled	Once initialized the CAN2 configuration is: Baudrate 125 kbps, 11-bit identifier. **Note:** CAN1 is clocked during CAN2 bootloader execution because CAN1 manages the communication between CAN2 and SRAM.
	CAN2_RX pin	Input	PB5 pin: CAN2 in reception mode
	CAN2_TX pin	Output	PB13 pin: CAN2 in transmission mode
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 kHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111010x (where x = 0 for write and x = 1 for read).
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB7 pin: data line is used in open-drain mode.
I2C2 bootloader	I2C2	Enabled	The I2C2 configuration is: I2C speed: up to 400 kHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111010x (where x = 0 for write and x = 1 for read).
	I2C2_SCL pin	Input/Output	PF1 pin: clock line is used in open-drain mode.
	I2C2_SDA pin	Input/Output	PF0 pin: data line is used in open-drain mode.

Table 55. STM32F40xxx/41xxx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
I2C3 bootloader	I2C3	Enabled	The I2C3 configuration is: I2C speed: up to 400 kHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111010x (where x = 0 for write and x = 1 for read).
	I2C3_SCL pin	Input/Output	PA8 pin: clock line is used in open-drain mode.
	I2C3_SDA pin	Input/Output	PC9 pin: data line is used in open-drain mode.
SPI1 bootloader	SPI1	Enabled	The SPI1 configuration is: slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in push-pull, pull-down mode
	SPI1_MISO pin	Output	PA6 pin: Slave data output line, used in push-pull, pull-down mode
	SPI1_SCK pin	Input	PA5 pin: Slave clock line, used in push-pull, pull-down mode
	SPI1_NSS pin	Input	PA4 pin: slave chip select pin used in push-pull, pull-down mode.
SPI2 bootloader	SPI2	Enabled	The SPI2 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI2_MOSI pin	Input	PI3 pin: Slave data Input line, used in push-pull, pull-down mode
	SPI2_MISO pin	Output	PI2 pin: Slave data output line, used in push-pull, pull-down mode
	SPI2_SCK pin	Input	PI1 pin: Slave clock line, used in push-pull, pull-down mode
	SPI2_NSS pin	Input	PI0 pin: slave chip select pin used in push-pull, pull-down mode.
DFU bootloader	USB	Enabled	USB OTG FS configured in forced device mode
	USB_DM pin	Input/Output	PA11: USB DM line.
	USB_DP pin		PA12: USB DP line No external pull-up resistor is required
CAN2 and DFU bootloaders	TIM11	Enabled	This timer is used to determine the value of the HSE. Once the HSE frequency is determined, the system clock is configured to 60 MHz using PLL and HSE.

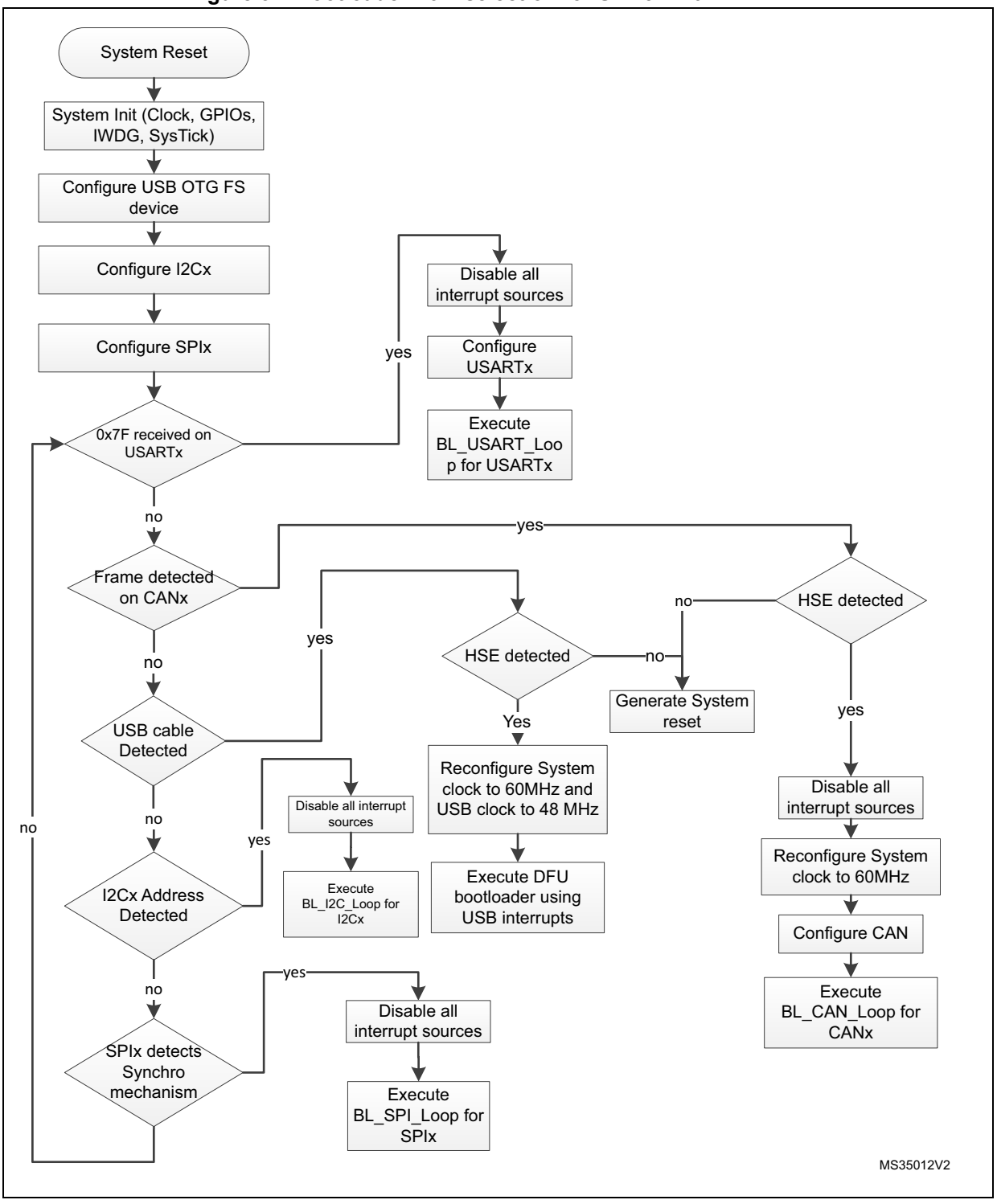
The system clock is derived from the embedded internal high-speed RC for USARTx, I2Cx and SPIx bootloaders. This internal clock is also used for CAN and DFU (USB FS Device) but only for the selection phase. An external clock multiple of 1 MHz (between 4 and 26 MHz) is required for CAN and DFU bootloader execution after the selection phase.

Note: Due to HSI deviation and since HSI is used to detect HSE value, the user must use low frequency rather than high frequency HSE crystal values (low frequency values are better detected due to larger error margin). For example, it is better to use 8 MHz instead of 25 MHz.

26.2.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

Figure 31. Bootloader V9.x selection for STM32F40xxx/41xxx



26.2.3 Bootloader version

The following table lists the STM32F40xxx/41xxx devices V9.x bootloader versions.

Table 56. STM32F40xxx/41xxx bootloader V9.x versions

Bootloader version number	Description	Known limitations
V9.0	This bootloader is an updated version of bootloader v3.1. This new version of bootloader supports I2C1, I2C2, I2C3, SPI1 and SPI2 interfaces. The RAM used by this bootloader is increased from 8Kb to 12Kb. The ID of this bootloader is 0x90. The connection time is increased.	– For the USART interface, two consecutive NACKs (instead of 1 NACK) are sent when a Read Memory or Write Memory command is sent and the RDP level is active. – For the CAN interface, the Write Unprotect command is not functional. Use Write Memory command and write directly to the option bytes in order to disable the write protection. After executing Go command (jump to user code) the bootloader resets AHB1ENR value to 0x0000 0000 and thus CCM RAM, when present, is not active (must be re-enabled by user code at startup)